Lattice Semiconductor Corporation - LFSCM3GA115EP1-5FFN1704C Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	942
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-OFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga115ep1-5ffn1704c

LatticeSC/M Family Data Sheet Introduction

January 2010 Data Sheet DS1004

Features

- **High Performance FPGA Fabric**
  - 15K to 115K four input Look-up Tables (LUT4s)
  - 139 to 942 I/Os
  - 700MHz global clock; 1GHz edge clocks
- **4 to 32 High Speed SERDES and flexiPCS™ (per Device)**
  - Performance ranging from 600Mbps to 3.8Gbps
  - Excellent Rx jitter tolerance (0.8UI at 3.125Gbps)
  - Low Tx jitter (0.25UI typical at 3.125Gbps)
  - Built-in Pre-emphasis and equalization
  - Low power (typically 105mW per channel)
  - Embedded Physical Coding Sublayer (PCS) provides pre-engineered implementation for the following standards:
    - GbE, XAUI, PCI Express, SONET, Serial RapidIO, 1G Fibre Channel, 2G Fibre Channel
- **2Gbps High Performance PURESPEED™ I/O**
  - Supports the following performance bandwidths
    - Differential I/O up to 2Gbps DDR (1GHz Clock)
    - Single-ended memory interfaces up to 800Mbps
  - 144 Tap programmable Input Delay (INDEL) block on every I/O dynamically aligns data to clock for robust performance
    - Dynamic bit Adaptive Input Logic (AIL) monitoring and control circuitry per pin that automatically ensures proper set-up and hold
    - Dynamic bus: uses control bus from DLL
    - Static per bit
  - Electrical standards supported:
    - LVCMOS 3.3/2.5/1.8/1.5/1.2, LVTTL
    - SSTL 3/2/18 I, II; HSTL 18/15 I, II
    - PCI, PCI-X
    - LVDS, Mini-LVDS, Bus-LVDS, MLVDS, LVPECL, RSDS
  - Programmable On Die Termination (ODT)
    - Includes Thevenin Equivalent and low power V_{TT} termination options
- **Memory Intensive FPGA**
  - sysMEM™ embedded Block RAM
    - 1 to 7.8 Mbits memory
    - True Dual Port/Pseudo Dual Port/Single Port
    - Dedicated FIFO logic for all block RAM
    - 500MHz performance
  - Additional 240K to 1.8Mbits distributed RAM
- **sysCLOCK™ Network**
  - Eight analog PLLs per device
    - Frequency range from 15MHz to 1GHz
    - Spread spectrum support
  - 12 DLLs per device with direct control of I/O delay
    - Frequency range from 100MHz to 700MHz
  - Extensive clocking network
    - 700MHz primary and 325 MHz secondary clocks
    - 1GHz I/O-connected edge clocks
  - Precision Clock Divider
    - Phase matched x2 and x4 division of incoming clocks
  - Dynamic Clock Select (DCS)
    - Glitch free clock MUX
- **Masked Array for Cost Optimization (MACO™) Blocks**
  - On-chip structured ASIC Blocks provide pre-engineered IP for low power, low cost system level integration
- **High Performance System Bus**
  - Ties FPGA elements together with a standard bus framework
    - Connects to peripheral user interfaces for run-time dynamic configuration
- **System Level Support**
  - IEEE standard 1149.1 Boundary Scan, plus ispTRACY™ internal logic analyzer
  - IEEE Standard 1532 in-system configuration
  - 1.2V and 1.0V operation
  - Onboard oscillator for initialization and general use
  - Embedded PowerPC microprocessor interface
  - Low cost wire-bond and high pin count flip-chip packaging
  - Low cost SPI Flash RAM configuration

Figure 2-3. Slice Diagram

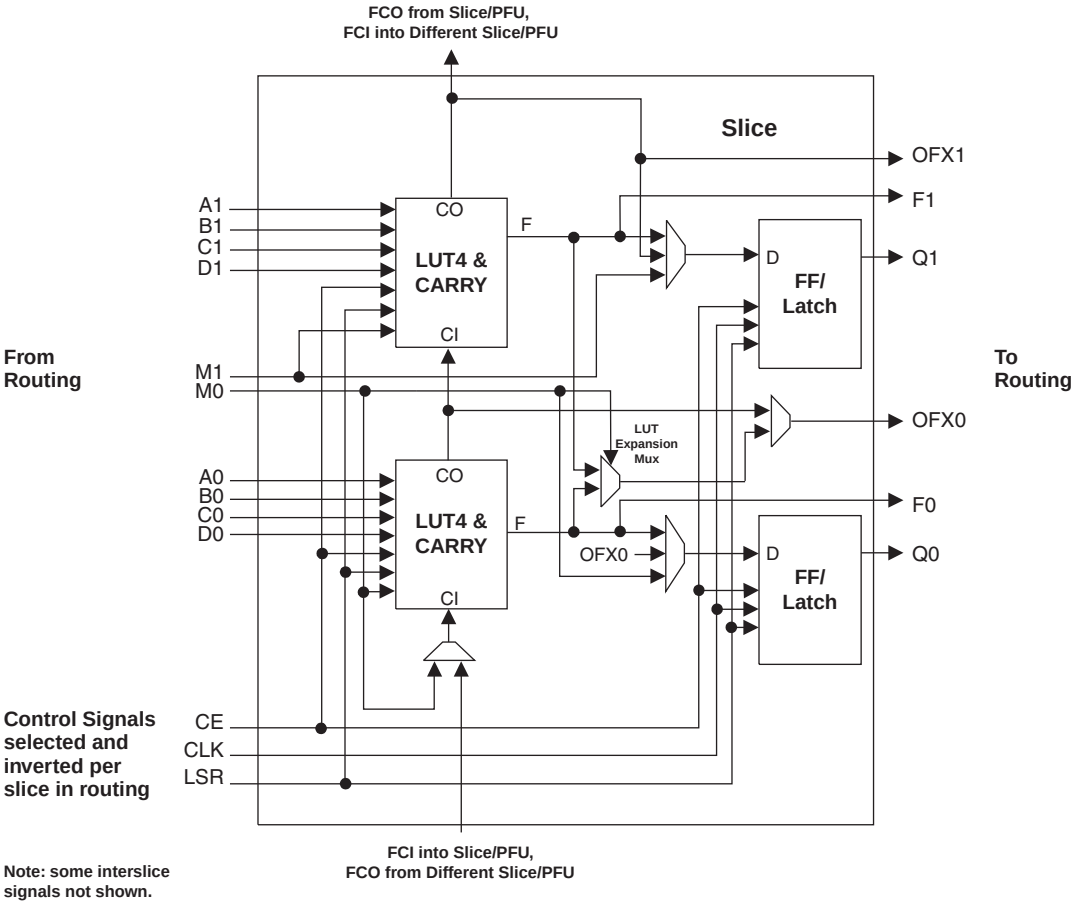


Table 2-1. Slice Signal Descriptions

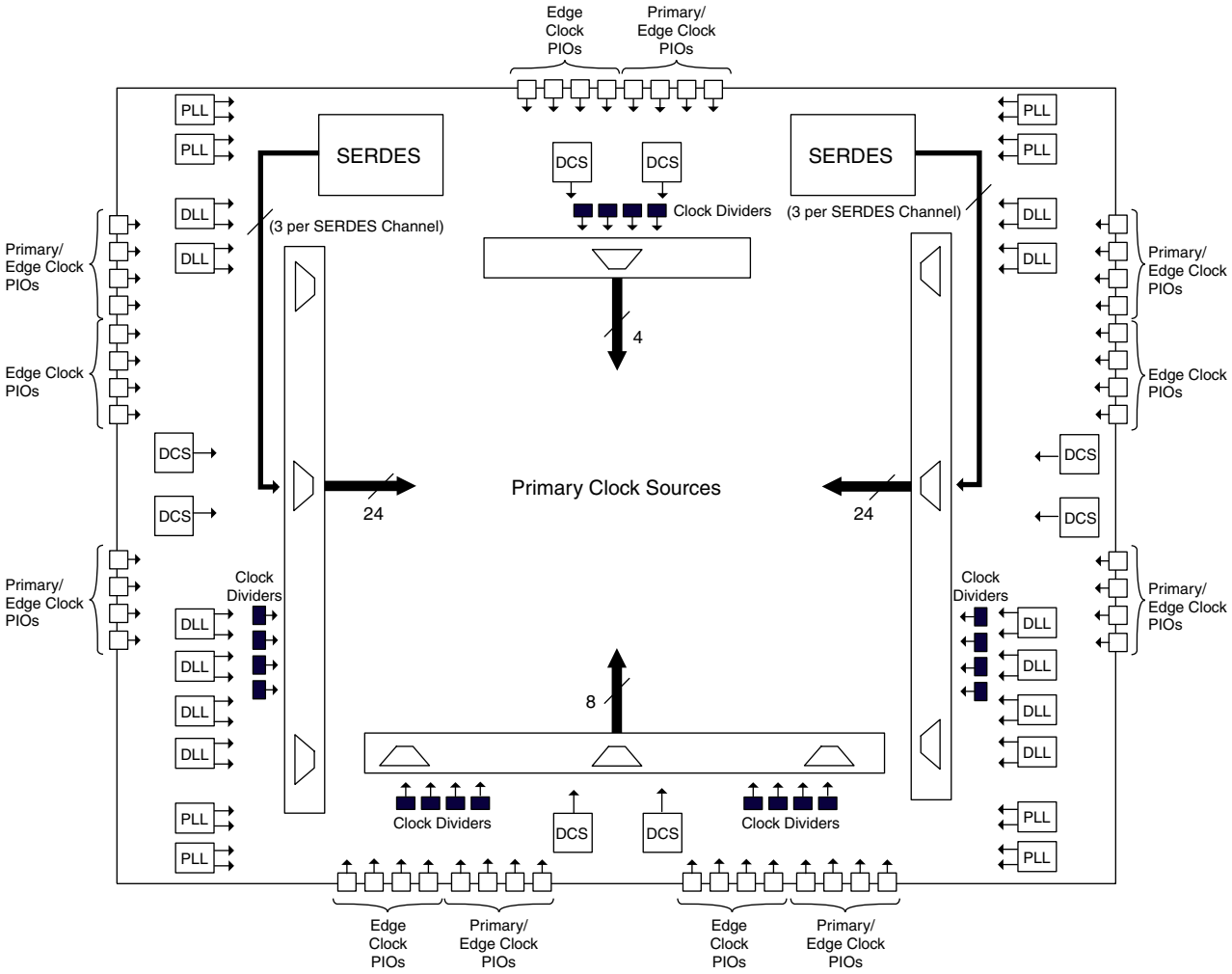
Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCI	Fast Carry In[1]
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8[2] MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output[2]

1. See Figure 2-2 for connection details.
2. Requires two PFUs.

- Two outputs per PLL
- Clock divider outputs
- Digital Clock Select (DCS) block outputs
- Three outputs per SERDES quad

Figure 2-5 shows the arrangement of the primary clock sources.

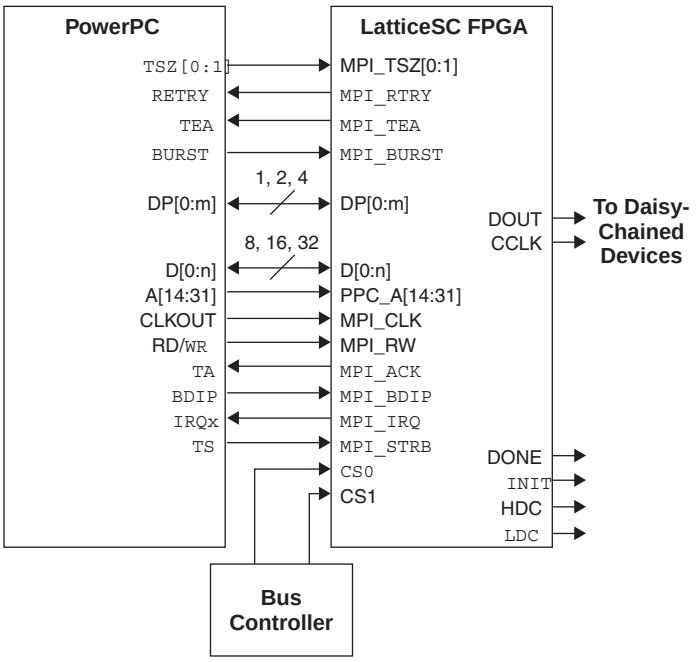
Figure 2-5. Clock Sources



Primary Clock Routing

The clock routing structure in LatticeSC devices consists of 12 Primary Clock lines per quadrant. The primary clocks are generated from 64:1 MUXs located in each quadrant. Three of the inputs to each 64:1 MUX comes from local routing, one is connected to GND and rest of the 60 inputs are from the primary clock sources. Figure 2-6 shows this clock routing.

Figure 2-32. PowerPCI and MPI Schematic



Configuration and Testing

The following section describes the configuration and testing features of the LatticeSC family of devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeSC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS33, 25 and 18 standards. For additional detail refer to technical information at the end of the data sheet.

Device Configuration

All LatticeSC devices contain three possible ports that can be used for device configuration. The serial port, which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration. The MPI port supports 8-bit, 16-bit or 32-bit configuration.

The serial port supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins. When sysCONFIG mode is not used, these dual-use pins are available for general purpose I/O. All I/Os for the sysCONFIG and MPI ports are in I/O bank #1.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next re-initialization sequence. For additional detail refer to technical information at the end of the data sheet.

Initialization and Standby Supply Current

The table below indicates initialization and standby supply current while operating at 85°C junction temperature (T_J), which is the high end of the commercial temperature range, and 105°C, which is the high end of the industrial temperature range. This data assumes all outputs are tri-stated and all inputs are configured as LVCMOS and held at V_{CCIO} or GND. The remaining SERDES supply current for V_{DDIB} and V_{DDOB} is detailed in the SERDES section of this data sheet. For power at your design temperature, it is recommended to use the Power Calculator tool which is accessible in ispLEVER or can be used as a standalone tool. For more information on supply current, see the reference to additional technical documentation available at the end of this data sheet.

Over Recommended Operating Conditions

Symbol	Condition	Parameter	Device	25°C Typ.[1]	85°C Max.[2]		105°C Max.[2]	Units
				All	-5, -6	-7	-5, -6	
I_{CC}	(VCC = 1.2V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	65	449	678	755	mA
			LFSC/M25	113	798	1255	1343	mA
			LFSC/M40	159	1178	2006	1981	mA
			LFSC/M80	276	2122	3827	3569	mA
			LFSC/M115	454	3376	—	5679	mA
	(VCC = 1.0V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	45	312	471	524	mA
			LFSC/M25	79	554	872	933	mA
			LFSC/M40	110	818	1393	1375	mA
			LFSC/M80	191	1473	2658	2478	mA
			LFSC/M115	315	2344	—	3943	mA
I_{CC12}		1.2V Power Supply Current for Configuration Logic, FPGA PLL, SERDES PLL and SERDES Analog Supplies	LFSC/M15	23	39	59	35	mA
			LFSC/M25	25	50	78	56	mA
			LFSC/M40	31	78	133	89	mA
			LFSC/M80	50	108	195	123	mA
			LFSC/M115	65	131	—	154	mA
I_{CCAUX}		Auxiliary Operating Power Supply Current	LFSC/M15	7	12	19	14	mA
			LFSC/M25	9	16	25	18	mA
			LFSC/M40	12	23	39	25	mA
			LFSC/M80	13	25	45	23	mA
			LFSC/M115	16	27	—	26	mA
I_{CCIO} and I_{CCJ}		Bank Power Supply Current (per bank)	LFSC/M15	0.1	0.2	0.3	0.2	mA
			LFSC/M25	0.3	0.6	1.0	0.7	mA
			LFSC/M40	0.4	0.9	1.5	1.0	mA
			LFSC/M80	0.5	1.1	2.1	1.3	mA
			LFSC/M115	0.7	1.5	—	1.8	mA

1. I_{CC} is specified at T_J = 25°C and typical V_{CC}.
2. I_{CC} is specified at the respective commercial and industrial maximum T_J and V_{CC} limits.

RSDS

Over Recommended Operating Conditions

Parameter Symbol	Description	Min.	Typ.	Max.	Units
V_{OD}	Output voltage, differential, R_T = 100 ohms	100	200	600	mV
V_{OS}	Output voltage, common mode	0.5	1.2	1.5	V
I_{RSDS}	Differential driver output current	1	2	6	mA
V_{THD}	Input voltage differential	100	—	—	mV
V_{CM}	Input common mode voltage	0.3	—	1.5	V
T_R, T_F	Output rise and fall times, 20% to 80%	—	500	—	ps
T_{ODUTY}	Output clock duty cycle	45	50	55	%

Note: Data is for 2mA drive. Other differential driver current options are available.

Typical Building Block Function Performance

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Pin to Pin Performance (LVCMOS25 12 mA Drive)

Function	-7*	Units
Basic Functions		
32-bit Decoder	6.65	ns
Combinatorial (Pin to LUT to Pin)	5.58	ns
Embedded Memory Functions (Single Port RAM)		
Pin to EBR Input Register Setup (Global Clock)	1.66	ns
EBR Output Clock to Pin (Global Clock)	8.54	ns
Distributed (PFU) RAM (Single Port RAM)		
Pin to PFU RAM Register Setup (Global Clock)	1.32	ns
PFU RAM Clock to Pin (Global Clock)	6.83	ns

*Typical performance per function

Register-to-Register Performance

Function	-7*	Units
Basic Functions		
32-Bit Decoder	539	MHz
64-Bit Decoder	517	MHz
16:1 MUX	1003	MHz
32:1 MUX	798	MHz
16-Bit Adder	672	MHz
64-Bit Adder	353	MHz
16-Bit Counter	719	MHz
64-Bit Counter	369	MHz
32x8 SP RAM (PFU, Output Registered)	768	MHz
128x8 SP RAM (PFU, Output Registered)	545	MHz
Embedded Memory Functions		
Single Port RAM (512x36 Bits)	372	MHz
True Dual Port RAM 1024x18 Bits (No EBR Out Reg)	326	MHz
True dual port RAM 1024x18 Bits (EBR Reg)	372	MHz
FIFO port (A: x36 bits, B: x9 Bits, No EBR Out Reg)	353	MHz
FIFO port (A: x36 bits, B: x9 Bits, EBR Reg)	375	MHz
True DP RAM Width Cascading (1024x72)	372	MHz
DSP Functions		
9x9 1-stage Multiplier	209	MHz
18x18 1-Stage Multiplier	155	MHz
9x9 3-Stage Pipelined Multiplier	373	MHz
18x18 4-Stage Pipelined Multiplier	314	MHz
9x9 Constant Multiplier	372	MHz

*Typical performance per function

LatticeSC/M External Switching Characteristics[3]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL)[2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t_{SU_IDLY}	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t_{H_IDLY}	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f_{MAX_PFU}	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f_{MAX_IO}	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t_{GC_SKEW}	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL)[1, 2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL)[2]								
t_{CO}	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t_{SU}	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t_{H}	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t_{SU_IDLY}	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t_{H_IDLY}	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t_{EC_SKEW}	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL)[2]								
t_{SU}	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t_{H}	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t_{SU_IDLY}	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t_{H_IDLY}	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

1. No PLL delay tuning (clock injection removal mode, system clock feedback).
2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.
3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters. Timing specs are for non-AIL applications.

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y6	PR42D	3	DIFFR_3	PR51D	3	DIFFR_3
W6	PR42C	3		PR51C	3	
Y2	PR42B	3		PR51B	3	
W2	PR42A	3		PR51A	3	
W7	PR40D	3		PR49D	3	
V8	PR40C	3		PR49C	3	
W4	PR40B	3		PR49B	3	
W3	PR40A	3		PR49A	3	
V5	PR39D	3		PR48D	3	
U6	PR39C	3		PR48C	3	
V3	PR39B	3		PR48B	3	
V4	PR39A	3		PR48A	3	
V10	PR38D	3		PR47D	3	
V9	PR38C	3		PR47C	3	
V2	PR38B	3		PR47B	3	
V1	PR38A	3		PR47A	3	
U8	PR36D	3		PR45D	3	
U7	PR36C	3		PR45C	3	
U2	PR36B	3		PR45B	3	
U1	PR36A	3		PR45A	3	
U5	PR35D	3		PR44D	3	
T6	PR35C	3		PR44C	3	
T1	PR35B	3		PR44B	3	
T2	PR35A	3		PR44A	3	
U9	PR34D	3		PR43D	3	
U10	PR34C	3	VREF1_3	PR43C	3	VREF1_3
R1	PR34B	3		PR43B	3	
R2	PR34A	3		PR43A	3	
T7	PR31D	3	PCLKC3_2	PR40D	3	PCLKC3_2
T8	PR31C	3	PCLKT3_2	PR40C	3	PCLKT3_2
R4	PR31B	3		PR40B	3	
R3	PR31A	3		PR40A	3	
T5	PR30D	3	PCLKC3_3	PR39D	3	PCLKC3_3
R5	PR30C	3	PCLKT3_3	PR39C	3	PCLKT3_3
P2	PR30B	3		PR39B	3	
P1	PR30A	3		PR39A	3	
T9	PR29D	3	PCLKC3_1	PR38D	3	PCLKC3_1
T10	PR29C	3	PCLKT3_1	PR38C	3	PCLKT3_1
P4	PR29B	3	PCLKC3_0	PR38B	3	PCLKC3_0
P3	PR29A	3	PCLKT3_0	PR38A	3	PCLKT3_0
P5	PR27D	2	PCLKC2_2	PR36D	2	PCLKC2_2
P6	PR27C	2	PCLKT2_2	PR36C	2	PCLKT2_2
N1	PR27B	2	PCLKC2_0	PR36B	2	PCLKC2_0
N2	PR27A	2	PCLKT2_0	PR36A	2	PCLKT2_0
R9	PR26D	2	PCLKC2_3	PR35D	2	PCLKC2_3
R8	PR26C	2	PCLKT2_3	PR35C	2	PCLKT2_3
M1	PR26B	2	PCLKC2_1	PR35B	2	PCLKC2_1
L1	PR26A	2	PCLKT2_1	PR35A	2	PCLKT2_1
N9	PR25D	2	DIFFR_2	PR23D	2	DIFFR_2
M9	PR25C	2	VREF1_2	PR23C	2	VREF1_2

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
K20	GND	-		GND	-	
K23	GND	-		GND	-	
K26	GND	-		GND	-	
K28	GND	-		GND	-	
K6	GND	-		GND	-	
K9	GND	-		GND	-	
L12	GND	-		GND	-	
L32	GND	-		GND	-	
L4	GND	-		GND	-	
M10	GND	-		GND	-	
M17	GND	-		GND	-	
M24	GND	-		GND	-	
N29	GND	-		GND	-	
N7	GND	-		GND	-	
P15	GND	-		GND	-	
P20	GND	-		GND	-	
P3	GND	-		GND	-	
P31	GND	-		GND	-	
R10	GND	-		GND	-	
R14	GND	-		GND	-	
R16	GND	-		GND	-	
R19	GND	-		GND	-	
R21	GND	-		GND	-	
R26	GND	-		GND	-	
T15	GND	-		GND	-	
T17	GND	-		GND	-	
T18	GND	-		GND	-	
T20	GND	-		GND	-	
T28	GND	-		GND	-	
T6	GND	-		GND	-	
U16	GND	-		GND	-	
U19	GND	-		GND	-	
U23	GND	-		GND	-	
U32	GND	-		GND	-	
U4	GND	-		GND	-	
V12	GND	-		GND	-	
V16	GND	-		GND	-	
V19	GND	-		GND	-	
V3	GND	-		GND	-	
V31	GND	-		GND	-	
W15	GND	-		GND	-	
W17	GND	-		GND	-	
W18	GND	-		GND	-	
W20	GND	-		GND	-	
W29	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W13	VCCAUX	-		VCCAUX	-	
W22	VCCAUX	-		VCCAUX	-	
Y21	GND	-		GND	-	
Y25	GND	-		GND	-	
C18	VCCIO1	-		VCCIO1	-	
D17	VCCIO1	-		VCCIO1	-	
F16	VCCIO1	-		VCCIO1	-	
G19	VCCIO1	-		VCCIO1	-	
J20	VCCIO1	-		VCCIO1	-	
K12	VCCIO1	-		VCCIO1	-	
K15	VCCIO1	-		VCCIO1	-	
L23	VCCIO1	-		VCCIO1	-	
Y9	GND	-		GND	-	
J9	VCCIO1	-		VCCIO1	-	
E3	VCCIO2	-		VCCIO2	-	
G6	VCCIO2	-		VCCIO2	-	
H4	VCCIO2	-		VCCIO2	-	
K7	VCCIO2	-		VCCIO2	-	
L3	VCCIO2	-		VCCIO2	-	
M11	VCCIO2	-		VCCIO2	-	
N6	VCCIO2	-		VCCIO2	-	
P4	VCCIO2	-		VCCIO2	-	
R9	VCCIO2	-		VCCIO2	-	
AA3	VCCIO3	-		VCCIO3	-	
AB7	VCCIO3	-		VCCIO3	-	
AC10	VCCIO3	-		VCCIO3	-	
AD4	VCCIO3	-		VCCIO3	-	
AE6	VCCIO3	-		VCCIO3	-	
AG3	VCCIO3	-		VCCIO3	-	
AK4	VCCIO3	-		VCCIO3	-	
T7	VCCIO3	-		VCCIO3	-	
U3	VCCIO3	-		VCCIO3	-	
V4	VCCIO3	-		VCCIO3	-	
W6	VCCIO3	-		VCCIO3	-	
Y10	VCCIO3	-		VCCIO3	-	
AD12	VCCIO4	-		VCCIO4	-	
AF15	VCCIO4	-		VCCIO4	-	
AF9	VCCIO4	-		VCCIO4	-	
AH10	VCCIO4	-		VCCIO4	-	
AH16	VCCIO4	-		VCCIO4	-	
AJ13	VCCIO4	-		VCCIO4	-	
AJ7	VCCIO4	-		VCCIO4	-	
AL14	VCCIO4	-		VCCIO4	-	
AL8	VCCIO4	-		VCCIO4	-	
AM11	VCCIO4	-		VCCIO4	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AC19	VTT_5	5		VTT_5	5	
AC20	VTT_5	5		VTT_5	5	
AD22	VTT_5	5		VTT_5	5	
AB24	VTT_6	6		VTT_6	6	
W23	VTT_6	6		VTT_6	6	
Y23	VTT_6	6		VTT_6	6	
N24	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
T23	VTT_7	7		VTT_7	7	
M12	VDDAX25_R	-		VDDAX25_R	-	
M23	VDDAX25_L	-		VDDAX25_L	-	
Y16	GND	-		GND	-	
Y14	GND	-		GND	-	
N21	VCC12	-		VCC12	-	
P22	VCC12	-		VCC12	-	
AA22	VCC12	-		VCC12	-	
AB21	VCC12	-		VCC12	-	
AB14	VCC12	-		VCC12	-	
AA13	VCC12	-		VCC12	-	
P13	VCC12	-		VCC12	-	
N14	VCC12	-		VCC12	-	
G26	NC	-		NC	-	
G9	NC	-		NC	-	
J12	NC	-		NC	-	
H12	NC	-		NC	-	
H23	NC	-		NC	-	
J23	NC	-		NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).
2. The LatticeSC/M40 and LatticeSC/M80 in an 1152-pin package support a 32-bit MPI interface.

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AP20	PB61B	5	
AH21	PB61C	5	
AH20	PB61D	5	
AM20	PB63A	5	
AM19	PB63B	5	
AJ21	PB63C	5	
AJ20	PB63D	5	
AK19	PB66A	5	
AK18	PB66B	5	
AE18	PB66C	5	
AD18	PB66D	5	
AN19	PB69A	5	
AN18	PB69B	5	
AG18	PB69C	5	
AF18	PB69D	5	
AP19	PB71A	5	
AP18	PB71B	5	
AJ18	PB71C	5	
AH18	PB71D	5	
AP17	PB73A	4	
AP16	PB73B	4	
AJ17	PB73C	4	
AH17	PB73D	4	
AN17	PB75A	4	
AN16	PB75B	4	
AE17	PB75C	4	
AD17	PB75D	4	
AK17	PB78A	4	
AK16	PB78B	4	
AG17	PB78C	4	
AF17	PB78D	4	
AM16	PB81A	4	
AM15	PB81B	4	
AJ15	PB81C	4	
AJ14	PB81D	4	
AL16	PB83A	4	
AL15	PB83B	4	
AG16	PB83C	4	
AF16	PB83D	4	
AP15	PB86A	4	
AP14	PB86B	4	
AH15	PB86C	4	
AH14	PB86D	4	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
F6	A_VDDOB0_R	-	
B4	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
F7	A_VDDOB1_R	-	
B5	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
E6	VCC12	-	
A5	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B6	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
A6	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
C6	VCC12	-	
D4	A_VDDIB1_R	-	
C7	VCC12	-	
D5	A_VDDIB2_R	-	
A7	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B7	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E7	VCC12	-	
A8	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
F8	A_VDDOB2_R	-	
B8	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
F9	A_VDDOB3_R	-	
B9	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
E8	VCC12	-	
A9	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B10	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
A10	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
C10	VCC12	-	
D6	A_VDDIB3_R	-	
G10	VCC12	-	
D7	B_VDDIB0_R	-	
E10	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
F10	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
K10	VCC12	-	
A11	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
D10	B_VDDOB0_R	-	
B11	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
D11	B_VDDOB1_R	-	
B12	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L10	VCC12	-	
A12	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
F11	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
E11	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
G11	VCC12	-	
D8	B_VDDIB1_R	-	
G12	VCC12	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
J17	PT81C	1	D20/PCLKT1_2/MPI_DATA20
D16	PT81B	1	MCA_CLK_P1_OUT
E16	PT81A	1	MCA_CLK_P1_IN
H15	PT78D	1	D21/PCLKC1_1/MPI_DATA21
H16	PT78C	1	D22/PCLKT1_1/MPI_DATA22
C15	PT78B	1	MCA_CLK_P2_OUT
C16	PT78A	1	MCA_CLK_P2_IN
L17	PT75D	1	MCA_DONE_OUT
K17	PT75C	1	BUSYN/RCLK/SCK
E17	PT75B	1	DP0/MPI_PAR0
F17	PT75A	1	MPI_TA
G17	PT73D	1	D23/MPI_DATA23
H17	PT73C	1	DP2/MPI_PAR2
A17	PT73B	1	PCLKC1_0
B17	PT73A	1	PCLKT1_0/MPI_CLK
G18	PT71D	1	DP3/PCLKC1_4/MPI_PAR3
H18	PT71C	1	D24/PCLKT1_4/MPI_DATA24
E18	PT71B	1	MPI_RETRY
F18	PT71A	1	A0/MPI_ADDR14
J18	PT69D	1	A1/MPI_ADDR15
J19	PT69C	1	A2/MPI_ADDR16
C20	PT69B	1	A3/MPI_ADDR17
C19	PT69A	1	A4/MPI_ADDR18
K18	PT66D	1	D25/PCLKC1_5/MPI_DATA25
L18	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D19	PT66B	1	A5/MPI_ADDR19
E19	PT66A	1	A6/MPI_ADDR20
H19	PT63D	1	D27/MPI_DATA27
H20	PT63C	1	VREF1_1
A18	PT63B	1	A7/MPI_ADDR21
B18	PT63A	1	A8/MPI_ADDR22
H21	PT61D	1	D28/PCLKC1_6/MPI_DATA28
J21	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A19	PT61B	1	A9/MPI_ADDR23
B19	PT61A	1	A10/MPI_ADDR24
H22	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J22	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F20	PT58B	1	A11/MPI_ADDR25
G20	PT58A	1	A12/MPI_ADDR26
K21	PT57D	1	D11/MPI_DATA11
K22	PT57C	1	D12/MPI_DATA12
A20	PT57B	1	A13/MPI_ADDR27
B20	PT57A	1	A14/MPI_ADDR28

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP26	PB41C	5		PB43C	5	
AN26	PB41D	5		PB43D	5	
AY30	PB43A	5		PB45A	5	
AY29	PB43B	5		PB45B	5	
AU30	PB43C	5		PB45C	5	
AU31	PB43D	5		PB45D	5	
AV27	PB44A	5		PB46A	5	
AV26	PB44B	5		PB46B	5	
AT28	PB44C	5		PB46C	5	
AT27	PB44D	5		PB46D	5	
BA29	PB45A	5		PB47A	5	
BA28	PB45B	5		PB47B	5	
AL25	PB45C	5		PB47C	5	
AM25	PB45D	5		PB47D	5	
BB29	PB47A	5		PB49A	5	
BB28	PB47B	5		PB49B	5	
AN25	PB47C	5		PB49C	5	
AP25	PB47D	5		PB49D	5	
AY27	PB48A	5	PCLKT5_3	PB50A	5	PCLKT5_3
AY26	PB48B	5	PCLKC5_3	PB50B	5	PCLKC5_3
AT25	PB48C	5	PCLKT5_4	PB50C	5	PCLKT5_4
AT24	PB48D	5	PCLKC5_4	PB50D	5	PCLKC5_4
AW27	PB49A	5	PCLKT5_5	PB51A	5	PCLKT5_5
AW26	PB49B	5	PCLKC5_5	PB51B	5	PCLKC5_5
AU29	PB49C	5		PB51C	5	
AU28	PB49D	5		PB51D	5	
BB27	PB51A	5	PCLKT5_0	PB53A	5	PCLKT5_0
BB26	PB51B	5	PCLKC5_0	PB53B	5	PCLKC5_0
AR25	PB51C	5		PB53C	5	
AR24	PB51D	5	VREF2_5	PB53D	5	VREF2_5
BA27	PB52A	5	PCLKT5_1	PB54A	5	PCLKT5_1
BA26	PB52B	5	PCLKC5_1	PB54B	5	PCLKC5_1
AP24	PB52C	5	PCLKT5_6	PB54C	5	PCLKT5_6
AN24	PB52D	5	PCLKC5_6	PB54D	5	PCLKC5_6
AV25	PB53A	5	PCLKT5_2	PB55A	5	PCLKT5_2
AV24	PB53B	5	PCLKC5_2	PB55B	5	PCLKC5_2
AU27	PB53C	5	PCLKT5_7	PB55C	5	PCLKT5_7
AU26	PB53D	5	PCLKC5_7	PB55D	5	PCLKC5_7
BA25	PB55A	5		PB57A	5	
BA24	PB55B	5		PB57B	5	
AU24	PB55C	5		PB57C	5	
AU25	PB55D	5		PB57D	5	
BB24	PB56A	5		PB58A	5	
BB25	PB56B	5		PB58B	5	
AM23	PB56C	5		PB58C	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP8	PB117D	4		PB131D	4	
AY3	PB119A	4		PB133A	4	
AW3	PB119B	4		PB133B	4	
AR6	PB119C	4		PB133C	4	
AR5	PB119D	4		PB133D	4	
AU5	PB120A	4		PB134A	4	
AV5	PB120B	4		PB134B	4	
AL12	PB120C	4		PB134C	4	
AL11	PB120D	4		PB134D	4	
AV3	PB121A	4		PB135A	4	
AV4	PB121B	4		PB135B	4	
AN9	PB121C	4		PB135C	4	
AN8	PB121D	4		PB135D	4	
AW1	PB123A	4		PB138A	4	
AY1	PB123B	4		PB138B	4	
AK14	PB123C	4	VREF1_4	PB138C	4	VREF1_4
AK13	PB123D	4		PB138D	4	
AV2	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AW2	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AM10	PB124C	4		PB139C	4	
AM9	PB124D	4		PB139D	4	
AV1	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AU1	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AL10	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AL9	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AT3	PROBE_VCC	-		PROBE_VCC	-	
AU2	PROBE_GND	-		PROBE_GND	-	
AP7	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AN7	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AR3	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AR4	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AP6	PR94D	3		PR116D	3	
AN6	PR94C	3		PR116C	3	
AT2	PR94B	3		PR116B	3	
AR2	PR94A	3		PR116A	3	
AM6	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AL6	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AP5	PR93B	3		PR115B	3	
AN5	PR93A	3		PR115A	3	
AL8	PR91D	3		PR112D	3	
AK8	PR91C	3		PR112C	3	
AP2	PR91B	3		PR112B	3	
AN2	PR91A	3		PR112A	3	
AJ12	PR90D	3		PR109D	3	
AH12	PR90C	3		PR109C	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
K14	VCC12	-		VCC12	-	
H11	B_VDDIB2_R	-		B_VDDIB2_R	-	
D8	B_HDINP2_R	-	PCS 3E1 CH 2 IN P	B_HDINP2_R	-	PCS 3E1 CH 2 IN P
E8	B_HDINN2_R	-	PCS 3E1 CH 2 IN N	B_HDINN2_R	-	PCS 3E1 CH 2 IN N
G5	VCC12	-		VCC12	-	
B9	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P
L12	B_VDDOB2_R	-		B_VDDOB2_R	-	
A9	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N
C5	B_VDDOB3_R	-		B_VDDOB3_R	-	
A10	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N
H5	VCC12	-		VCC12	-	
B10	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P
E9	B_HDINN3_R	-	PCS 3E1 CH 3 IN N	B_HDINN3_R	-	PCS 3E1 CH 3 IN N
D9	B_HDINP3_R	-	PCS 3E1 CH 3 IN P	B_HDINP3_R	-	PCS 3E1 CH 3 IN P
J13	VCC12	-		VCC12	-	
H12	B_VDDIB3_R	-		B_VDDIB3_R	-	
J12	VCC12	-		VCC12	-	
M14	B_REFCLKN_R	-		B_REFCLKN_R	-	
L14	B_REFCLKP_R	-		B_REFCLKP_R	-	
J14	VCC12	-		VCC12	-	
G12	C_VDDIB0_R	-		C_VDDIB0_R	-	
D10	C_HDINP0_R	-	PCS 3E2 CH 0 IN P	C_HDINP0_R	-	PCS 3E2 CH 0 IN P
E10	C_HDINN0_R	-	PCS 3E2 CH 0 IN N	C_HDINN0_R	-	PCS 3E2 CH 0 IN N
H6	VCC12	-		VCC12	-	
B11	C_HDOUTP0_R	-	PCS 3E2 CH 0 OUT P	C_HDOUTP0_R	-	PCS 3E2 CH 0 OUT P
M12	C_VDDOB0_R	-		C_VDDOB0_R	-	
A11	C_HDOUTN0_R	-	PCS 3E2 CH 0 OUT N	C_HDOUTN0_R	-	PCS 3E2 CH 0 OUT N
L11	C_VDDOB1_R	-		C_VDDOB1_R	-	
A12	C_HDOUTN1_R	-	PCS 3E2 CH 1 OUT N	C_HDOUTN1_R	-	PCS 3E2 CH 1 OUT N
K11	VCC12	-		VCC12	-	
B12	C_HDOUTP1_R	-	PCS 3E2 CH 1 OUT P	C_HDOUTP1_R	-	PCS 3E2 CH 1 OUT P
E11	C_HDINN1_R	-	PCS 3E2 CH 1 IN N	C_HDINN1_R	-	PCS 3E2 CH 1 IN N
D11	C_HDINP1_R	-	PCS 3E2 CH 1 IN P	C_HDINP1_R	-	PCS 3E2 CH 1 IN P
H13	VCC12	-		VCC12	-	
C6	C_VDDIB1_R	-		C_VDDIB1_R	-	
H15	VCC12	-		VCC12	-	
G13	C_VDDIB2_R	-		C_VDDIB2_R	-	
D12	C_HDINP2_R	-	PCS 3E2 CH 2 IN P	C_HDINP2_R	-	PCS 3E2 CH 2 IN P
E12	C_HDINN2_R	-	PCS 3E2 CH 2 IN N	C_HDINN2_R	-	PCS 3E2 CH 2 IN N
J9	VCC12	-		VCC12	-	
B13	C_HDOUTP2_R	-	PCS 3E2 CH 2 OUT P	C_HDOUTP2_R	-	PCS 3E2 CH 2 OUT P
K10	C_VDDOB2_R	-		C_VDDOB2_R	-	
A13	C_HDOUTN2_R	-	PCS 3E2 CH 2 OUT N	C_HDOUTN2_R	-	PCS 3E2 CH 2 OUT N
J10	C_VDDOB3_R	-		C_VDDOB3_R	-	
A14	C_HDOUTN3_R	-	PCS 3E2 CH 3 OUT N	C_HDOUTN3_R	-	PCS 3E2 CH 3 OUT N

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L8	VCCIO2	-		VCCIO2	-	
M3	VCCIO2	-		VCCIO2	-	
P7	VCCIO2	-		VCCIO2	-	
R4	VCCIO2	-		VCCIO2	-	
T12	VCCIO2	-		VCCIO2	-	
U8	VCCIO2	-		VCCIO2	-	
V3	VCCIO2	-		VCCIO2	-	
W11	VCCIO2	-		VCCIO2	-	
Y7	VCCIO2	-		VCCIO2	-	
AB3	VCCIO3	-		VCCIO3	-	
AC7	VCCIO3	-		VCCIO3	-	
AD11	VCCIO3	-		VCCIO3	-	
AE4	VCCIO3	-		VCCIO3	-	
AF8	VCCIO3	-		VCCIO3	-	
AG12	VCCIO3	-		VCCIO3	-	
AH3	VCCIO3	-		VCCIO3	-	
AJ7	VCCIO3	-		VCCIO3	-	
AK11	VCCIO3	-		VCCIO3	-	
AL4	VCCIO3	-		VCCIO3	-	
AM8	VCCIO3	-		VCCIO3	-	
AP3	VCCIO3	-		VCCIO3	-	
AR7	VCCIO3	-		VCCIO3	-	
AU4	VCCIO3	-		VCCIO3	-	
AL16	VCCIO4	-		VCCIO4	-	
AM13	VCCIO4	-		VCCIO4	-	
AM19	VCCIO4	-		VCCIO4	-	
AR11	VCCIO4	-		VCCIO4	-	
AR17	VCCIO4	-		VCCIO4	-	
AT14	VCCIO4	-		VCCIO4	-	
AT20	VCCIO4	-		VCCIO4	-	
AT8	VCCIO4	-		VCCIO4	-	
AW15	VCCIO4	-		VCCIO4	-	
AW21	VCCIO4	-		VCCIO4	-	
AW9	VCCIO4	-		VCCIO4	-	
AY12	VCCIO4	-		VCCIO4	-	
AY18	VCCIO4	-		VCCIO4	-	
AY6	VCCIO4	-		VCCIO4	-	
AL27	VCCIO5	-		VCCIO5	-	
AM24	VCCIO5	-		VCCIO5	-	
AM30	VCCIO5	-		VCCIO5	-	
AR26	VCCIO5	-		VCCIO5	-	
AR32	VCCIO5	-		VCCIO5	-	
AT23	VCCIO5	-		VCCIO5	-	
AT29	VCCIO5	-		VCCIO5	-	
AT35	VCCIO5	-		VCCIO5	-	

Conventional Packaging

Commercial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-7F256C	-7	fpBGA	256	COM	15.2
LFSC3GA15E-6F256C	-6	fpBGA	256	COM	15.2
LFSC3GA15E-5F256C	-5	fpBGA	256	COM	15.2
LFSC3GA15E-7F900C	-7	fpBGA	900	COM	15.2
LFSC3GA15E-6F900C	-6	fpBGA	900	COM	15.2
LFSC3GA15E-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-7F256C	-7	fpBGA	256	COM	15.2
LFSCM3GA15EP1-6F256C	-6	fpBGA	256	COM	15.2
LFSCM3GA15EP1-5F256C	-5	fpBGA	256	COM	15.2
LFSCM3GA15EP1-7F900C	-7	fpBGA	900	COM	15.2
LFSCM3GA15EP1-6F900C	-6	fpBGA	900	COM	15.2
LFSCM3GA15EP1-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-7F900C	-7	fpBGA	900	COM	25.4
LFSC3GA25E-6F900C	-6	fpBGA	900	COM	25.4
LFSC3GA25E-5F900C	-5	fpBGA	900	COM	25.4
LFSC3GA25E-7FF1020C[1]	-7	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-6FF1020C[1]	-6	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-5FF1020C[1]	-5	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-7F900C	-7	fpBGA	900	COM	25.4
LFSCM3GA25EP1-6F900C	-6	fpBGA	900	COM	25.4
LFSCM3GA25EP1-5F900C	-5	fpBGA	900	COM	25.4
LFSCM3GA25EP1-7FF1020C[1]	-7	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-6FF1020C[1]	-6	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-5FF1020C[1]	-5	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.